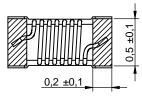
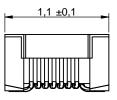
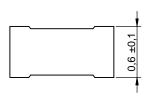
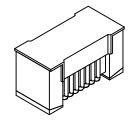
Dimensions: [mm]





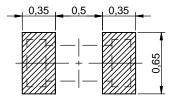






Scale - 25:1

Recommended Land Pattern: [mm]



Scale - 25:1

Certification:

Self Resonant Frequency

Properties

Q-Factor

Inductance

DC Resistance

Rated Current

Electrical Properties:

RoHS Approval	Compliant [2011/65/EU&2015/863]
REACh Approval	Conform or declared [(EC)1907/2006]
Halogen Free	Conform [JEDEC JS709B]
Halogen Free	Conform [IEC 61249-2-21]
Component Qualification	AEC-Q200 Grade 1

Test conditions

250 MHz

250 MHz

@ 20 °C

 $\Delta T = 20 \text{ K}$

Q

Value

13

27

0.14

870

4200

Unit Tol.

nΗ ±2%

Ω max.

mΑ

MHz min.

min.

max.

Schematic:



General Information:

CHECKED

JoMa

REVISION

003.000

Ambient Temperature (referring to $I_{\rm R}$)	-40 up to +105 °C
Operating Temperature	-40 up to +125 °C
Storage Conditions (in original packaging)	< 40 °C; < 75 % RH
Moisture Sensitivity Level (MSL)	1













Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg Germany Tel. +49 (0) 79 42 945 - 0

www.we-online.com eiSos@we-online.com

DESCRIPTION				
WE-KI	HC SMT	High Curr	ent Wire	
Wound	Ceram	ic Inducto	r	ORDER COD
				744

DATE (YYYY-MM-DD)

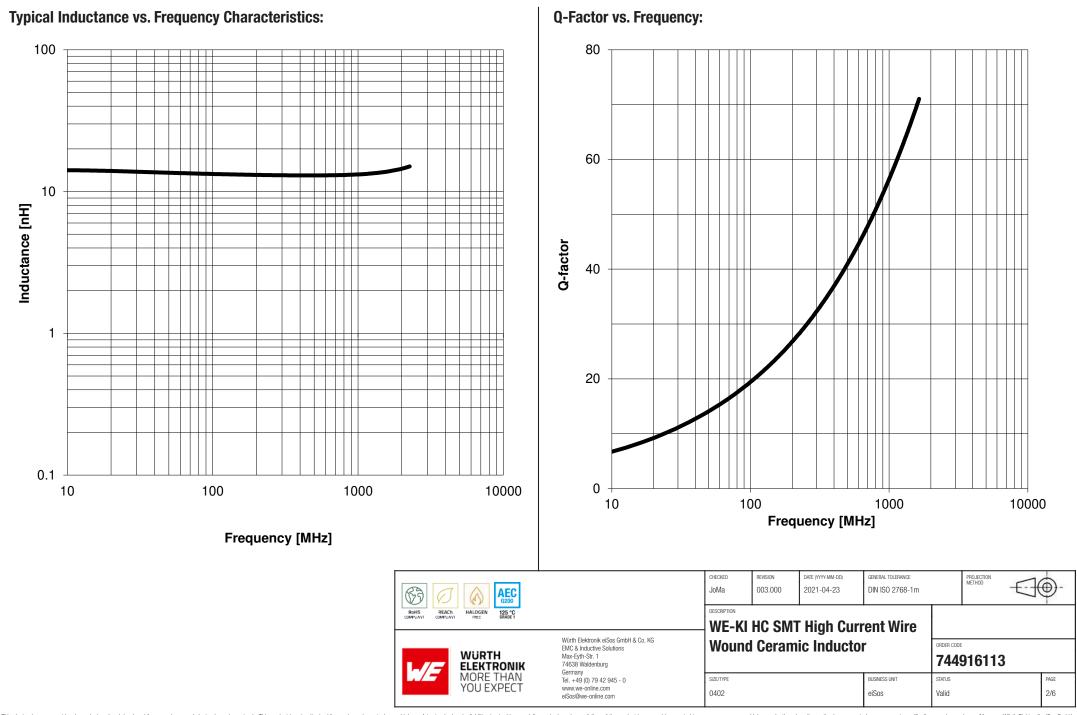
2021-04-23

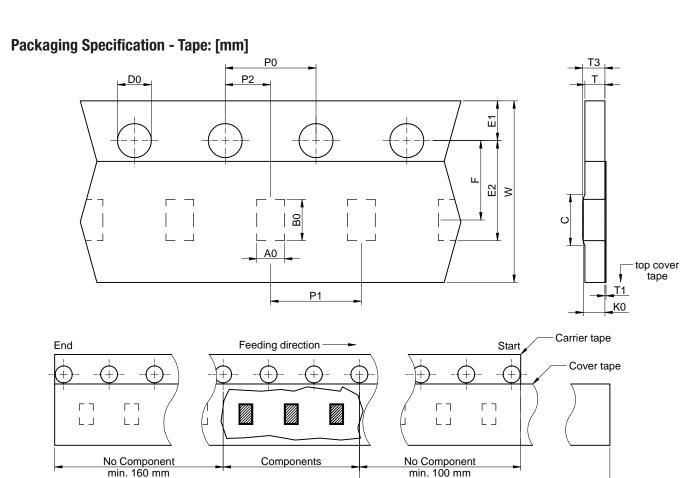
744916113 BUSINESS UNIT STATUS

GENERAL TOLERANCE

DIN ISO 2768-1m

PROJECTION METHOD





Packaging is referred to the international standard IEC 60286-3; 2013

tolerance size
 k
 B
 C
 D
 N
 W1
 W2
 W3
 W3

 tolerance
 ±2,0
 min.
 ±0,8
 min.
 min.
 +1.5
 max.
 min.
 max.

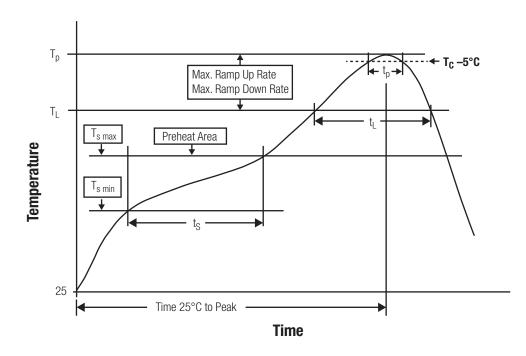
 Tape width
 8 mm
 178
 1.5
 13
 20.2
 50
 8.4
 14.4
 7.9
 10.9



VPE / packaging unit

Cover Tape min. 400 mm

Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

Profile Feature		Value
Preheat Temperature Min	T _{s min}	150 °C
Preheat Temperature Max	T _{s max}	200 °C
Preheat Time t_s from $T_{s min}$ to $T_{s max}$	t _s	60 - 120 seconds
Ramp-up Rate (T _L to T _P)		3 °C/ second max.
Liquidous Temperature	T _L	217 °C
Time t _L maintained above T _L	t _L	60 - 150 seconds
Peak package body temperature	T _p	$T_p \le T_c$, see Table below
Time within 5°C of actual peak temperature	t p	20 - 30 seconds
Ramp-down Rate (T _P to T _L)		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

refer to IPC/ JEDEC J-STD-020E

Package Classification Reflow Temperature (T_c):

Properties	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm³ >2000
PB-Free Assembly I Package Thickness < 1.6 mm	260 °C	260 °C	260 °C
PB-Free Assembly Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly I Package Thickness > 2.5 mm	250 °C	245 °C	245 °C

refer to IPC/ JEDEC J-STD-020E

B AI	EC	JoMa	REVISION 003.000	DATE (YYYY-MM-DD) 2021-04-23	DIN ISO 2768-1m		PROJECTION METHOD) -
ROME COMPLIANT HALOGEN 125	Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg	WE-KI HC SMT High Current Wire Wound Ceramic Inductor				ORDER CODE 744916113			
MORE TH YOU EXPE		SIZE/TYPE 0402			BUSINESS UNIT eiSos	status Valid		1	PAGE 4/6

Cautions and Warnings:

The following conditions apply to all goods within the product series of WE-KIHC of Würth Elektronik eiSos GmbH & Co. KG:

General:

- This electronic component is designed and manufactured for use in general electronic equipment.
- Würth Elektronik must be asked for written approval (following the PPAP procedure) before incorporating the components into any
 equipment in fields such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control,
 ship control), transportation signal, disaster prevention, medical, public information network etc. where higher safety and reliability are
 especially required and/or if there is the possibility of direct damage or human injury.
- Electronic components that will be used in safety-critical or high-reliability applications, should be pre-evaluated by the customer.
- The component is designed and manufactured to be used within the datasheet specified values. If the usage and operation conditions
 specified in the datasheet are not met, the wire insulation may be damaged or dissolved.
- Do not drop or impact the components, the component may be damaged.
- Würth Elektronik products are qualified according to international standards, which are listed in each product reliability report. Würth
 Elektronik does not warrant any customer qualified product characteristics beyond Würth Elektroniks' specifications, for its validity and
 sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the authority of the customer. All technical specifications for standard products also apply to customer specific products.

Product specific:

Soldering:

- The solder profile must comply with the technical product specifications. All other profiles will void the warranty.
- · All other soldering methods are at the customers' own risk.
- Strong forces which may affect the coplanarity of the components' electrical connection with the PCB (i.e. pins), can damage the part, resulting in avoid of the warranty.

Cleaning and Washing:

- Washing agents used during the production to clean the customer application might damage or change the characteristics of the wire
 insulation, marking or plating. Washing agents may have a negative effect on the long-term functionality of the product.
- Using a brush during the cleaning process may break the wire due to its small diameter. Therefore, we do not recommend using a brush during the PCB cleaning process.

Potting:

If the product is potted in the customer application, the potting material might shrink or expand during and after hardening. Shrinking
could lead to an incomplete seal, allowing contaminants into the core. Expansion could damage the component. We recommend a
manual inspection after potting to avoid these effects.

Storage Conditions:

- storage of Würth Elektronik products for longer than 12 months is not recommended. Within other effects, the terminals may suffer
 degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of
 shipment.
- · Do not expose the components to direct sunlight.
- The storage conditions in the original packaging are defined according to DIN EN 61760-2.
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components.

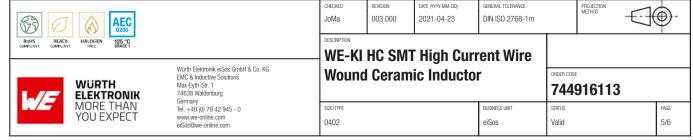
Packaging:

• The packaging specifications apply only to purchase orders comprising whole packaging units. If the ordered quantity exceeds or is lower than the specified packaging unit, packaging in accordance with the packaging specifications cannot be ensured.

Handling:

- Violation of the technical product specifications such as exceeding the nominal rated current will void the warranty.
- Applying currents with audio-frequency signals may result in audible noise due to the magnetostrictive material properties.
- The temperature rise of the component must be taken into consideration. The operating temperature is comprised of ambient
 temperature and temperature rise of the component. The operating temperature of the component shall not exceed the maximum
 temperature specified.

These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.



Important Notes

The following conditions apply to all goods within the product range of Würth Elektronik eiSos GmbH & Co. KG:

1. General Customer Responsibility

Some goods within the product range of Würth Elektronik eiSos GmbH & Co. KG contain statements regarding general suitability for certain application areas. These statements about suitability are based on our knowledge and experience of typical requirements concerning the areas, serve as general guidance and cannot be estimated as binding statements about the suitability for a customer application. The responsibility for the applicability and use in a particular customer design is always solely within the authority of the customer. Due to this fact it is up to the customer to evaluate, where appropriate to investigate and decide whether the device with the specific product characteristics described in the product specification is valid and suitable for the respective customer application or not.

2. Customer Responsibility related to Specific, in particular Safety-Relevant Applications

It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component. Therefore, customer is cautioned to verify that data sheets are current before placing orders. The current data sheets can be downloaded at www.we-online.com.

3. Best Care and Attention

Any product-specific notes, cautions and warnings must be strictly observed. Any disregard will result in the loss of warranty.

4. Customer Support for Product Specifications

Some products within the product range may contain substances which are subject to restrictions in certain jurisdictions in order to serve specific technical requirements. Necessary information is available on request. In this case the field sales engineer or the internal sales person in charge should be contacted who will be happy to support in this matter.

5. Product R&D

Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

6. Product Life Cycle

Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC-Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

7. Property Rights

All the rights for contractual products produced by Würth Elektronik eiSos GmbH & Co. KG on the basis of ideas, development contracts as well as models or templates that are subject to copyright, patent or commercial protection supplied to the customer will remain with Würth Elektronik eiSos GmbH & Co. KG does not warrant or represent that any license, either expressed or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, application, or process in which Würth Elektronik eiSos GmbH & Co. KG components or services are used.

8. General Terms and Conditions

Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms and Conditions of Würth Elektronik eiSos Group", last version available at www.we-online.com.

